



# Mixed Signal ICs for Space

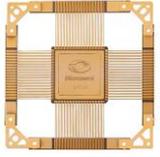
Microsemi Space Forum 2015

Dorian Johnson  
Product Marketing Manager – High Reliability ICs



Microsemi  
SPACE FORUM

# Mixed Signal ICs for Space



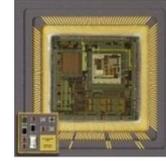
## New Products

- SSM
- Telemetry
- Power Drive/Motor Control
- High Side Drivers
- Diode Array



## Legacy

- 30+ yrs
- PWM Controllers
- Regulators
- Drivers
- QML listed



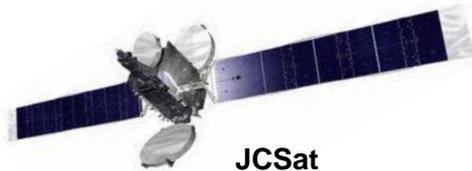
## Custom

- 15+ years
- Drivers
- Controllers
- Amplifiers
- Relays
- Telemetry
- Sensor Interface
- Motor Control

# Microsemi Mixed Signal Space Heritage

## ■ Microsemi Space heritage

- Broad space portfolio since 1957
- First Mixed Signal ICs screened for space in 1985
- First Mixed Signal ICs specifically designed & manufactured for space applications in 1995
- Our custom ICs reside in Spacecraft Control Electronics units that are installed in at least 36 spacecraft that are already in space
- Examples are:



# New Products

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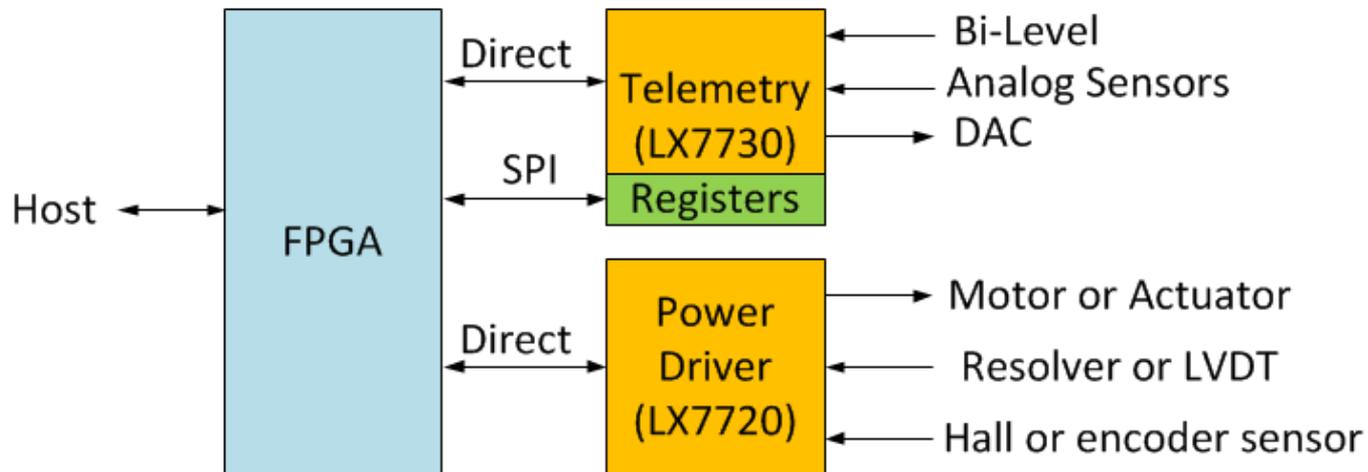
-  Space System Managers –LX7730 and LX7720
-  AAHS298B High Side Driver
-  LX7710 Diode Array

# Space System Managers

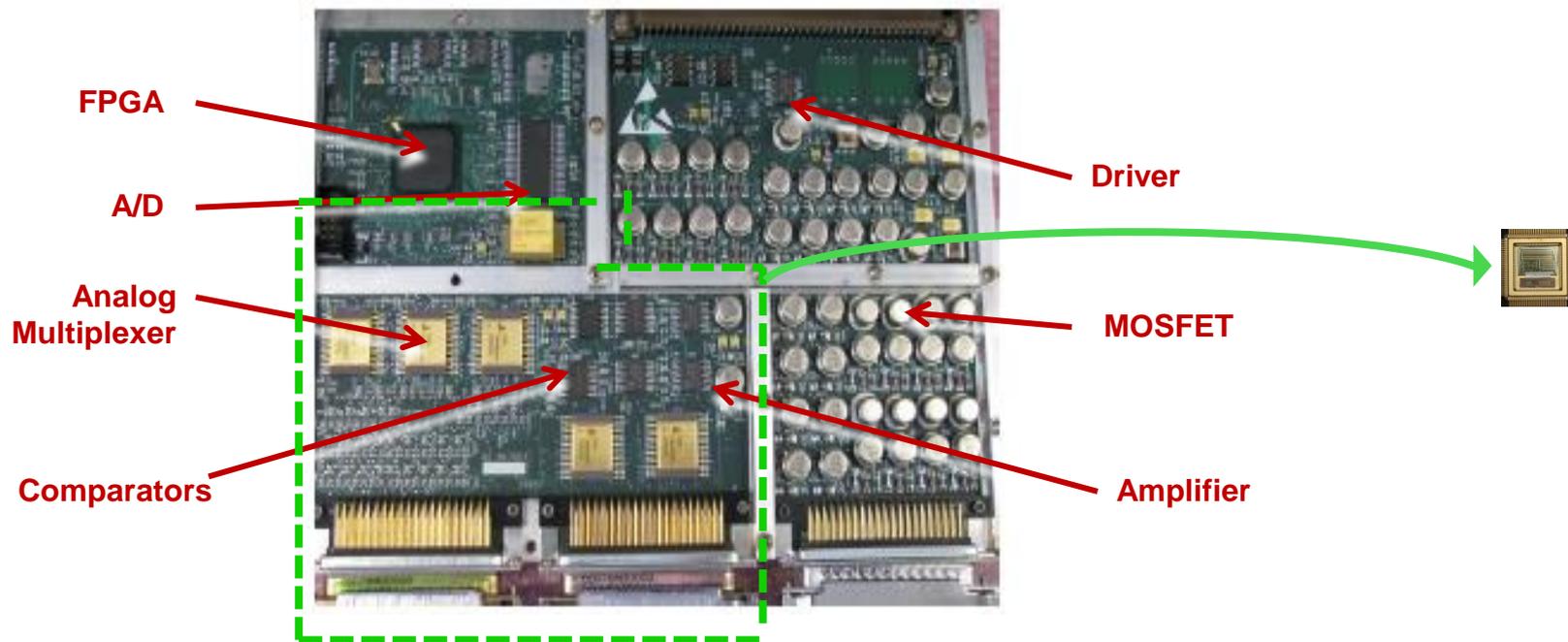
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# Space System Manager Concept

- The Space System Manager (SSM) is a special purpose, off-the-shelf, analog mixed signal IC that is used with a FPGA
- The solution reduces part count resulting in smaller size and weight and increased reliability
- The SSM ICs add power and mixed signal capability to supplement the digital functionality and flexibility of the FPGA
- SSMs provide a higher level of integration than basic devices by specifically focusing on common spacecraft interfaces
- Through FPGA programmability, the SSM can be adjusted to particular settings by changing the internal command registers



# Space System Manager vs. Discrete Components

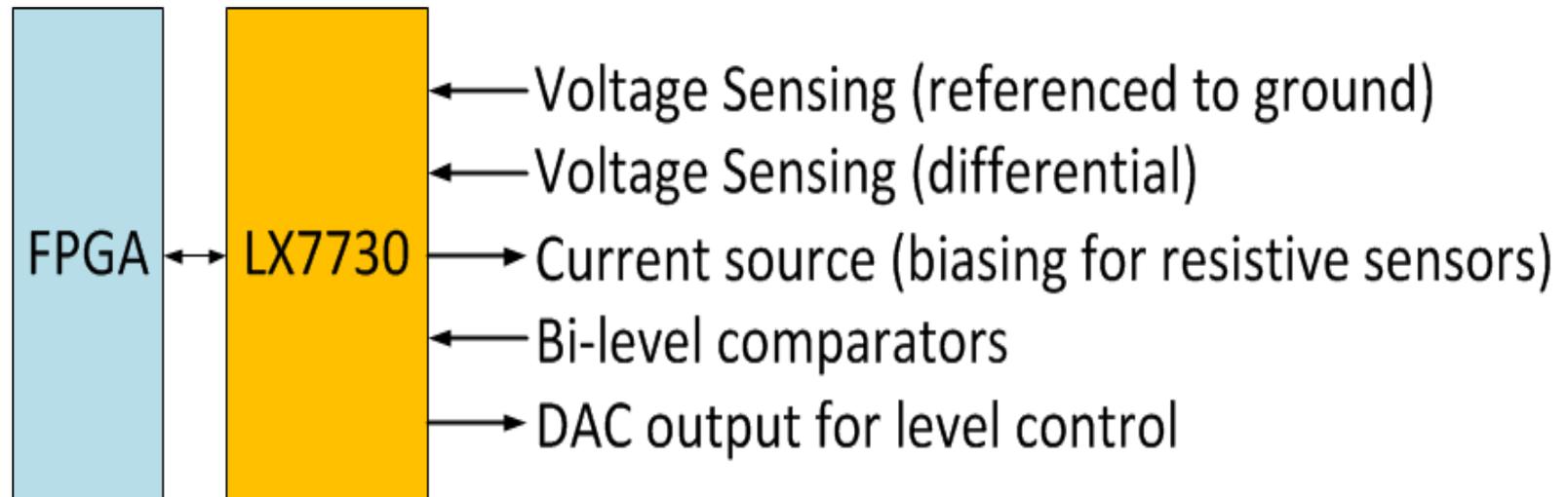


- A typical circuit uses an FPGA with analog interface functions implemented with many single function ICs and discrete components.
- SSM integrates commonly used functions into one package to reduce circuit board area and weight.
- Although utilization may not be 100% for the space system manager, it is still likely to be a more compact solution.

# The LX7730 Telemetry Controller SSM

The LX7730 is a Telemetry Controller is the first SSM.

- 64 channel MUX
- Break-before-make switching
- 25kSPS 12 bit ADC
- 2% Precision Adjustable Current Source
- 1% Precision 5.00V Source
- Parallel or Dual SPI Interface
- Threshold Monitoring
- 8 x Bi-level Logic
- 10 bit DAC
- Radiation Tolerant
  - 100krad TID, 50kad ELDR



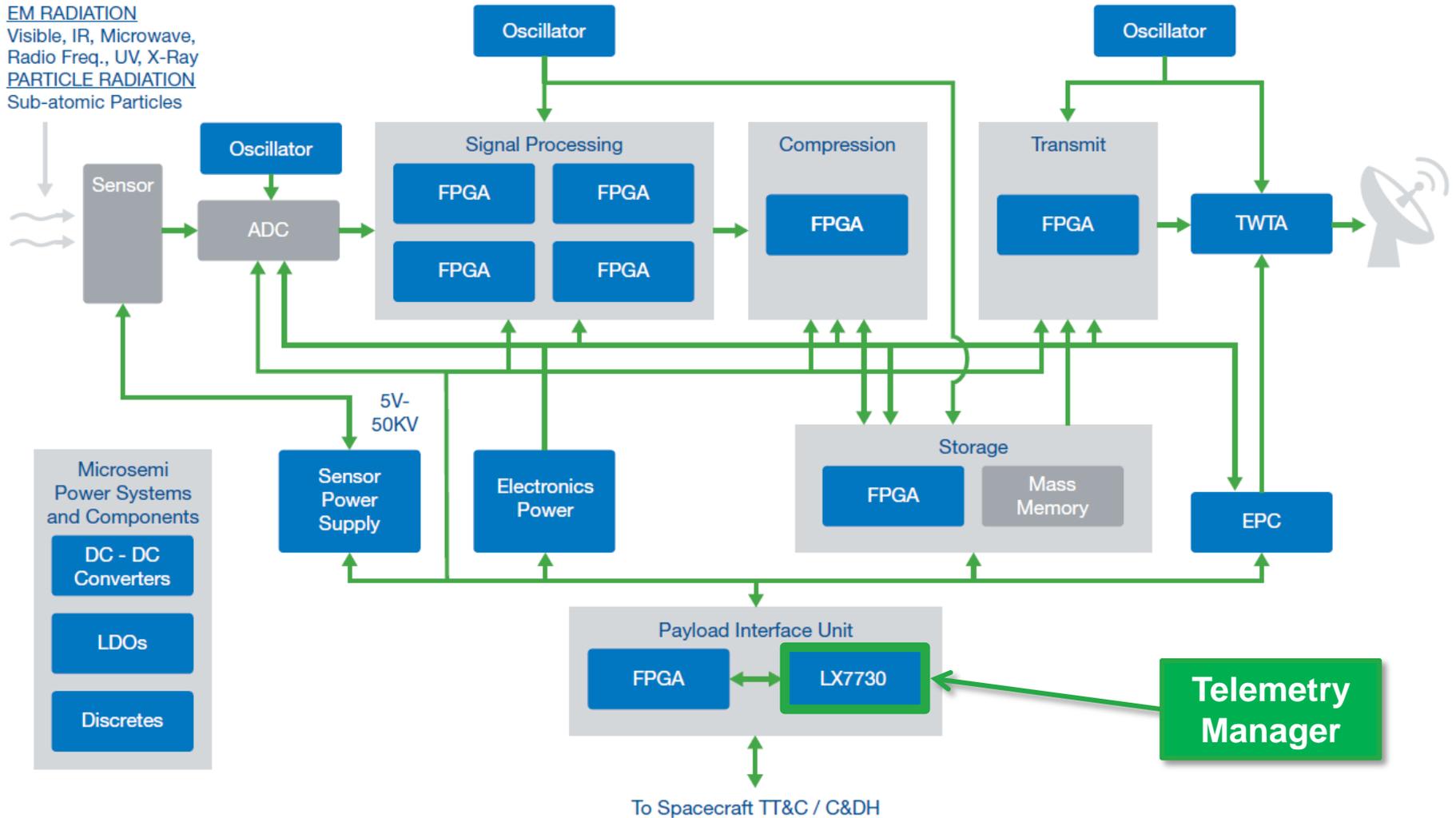
# Space System Managers in Remote Sensing Payload

## EM RADIATION

Visible, IR, Microwave,  
Radio Freq., UV, X-Ray

## PARTICLE RADIATION

Sub-atomic Particles

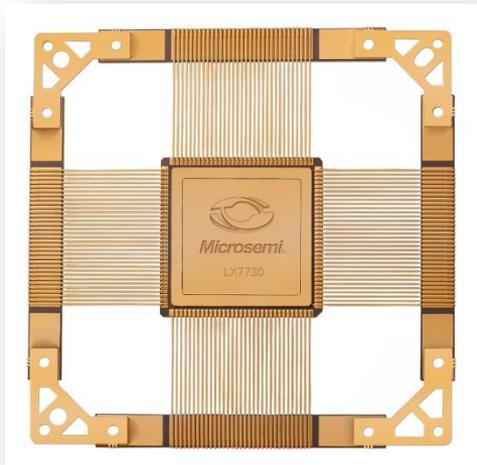


*The LX7730 complements other Microsemi space products*

# LX7730 Product Availability

## LX7730 availability

- NOT ITAR - EAR 9A515.e.
- Engineering Samples LX7730-ES: **NOW**
- Evaluation Board LX7730-EVB: **NOW**
- Class S built Samples Q3 2015
- Qualification Testing Complete Q1 2016
- QML Class V certification: Targeting mid-2016



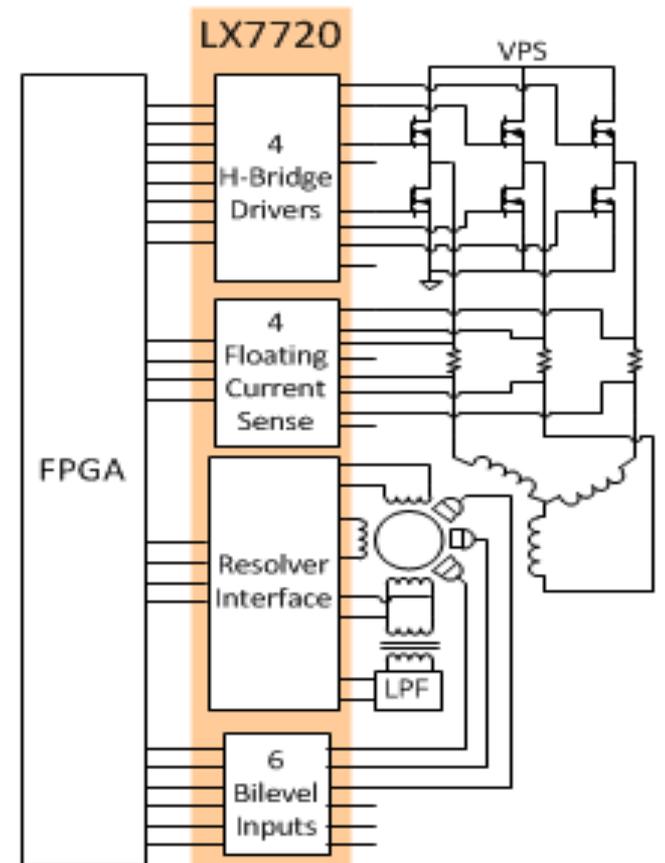
132 pin ceramic quad flat pack

# LX7720 Power Driver / Motor Controller

The LX7720 Power Driver with Position Feedback is the second SSM

## Features

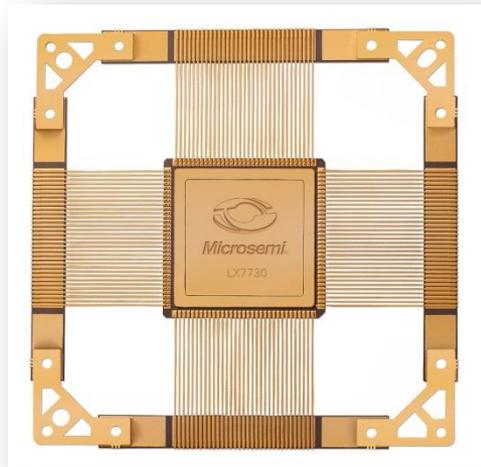
- 4 half-bridge Nch MOSFET drivers
- 4 floating differential current sensors
- Sigma-delta resolver transformer driver
- 3 differential resolver sense inputs
- 6 bi-level logic inputs
- Fault detection
- Provides motor control for:
  - Stepper, Brushless DC, PMSM motor driver



# LX7720 Product Availability

## LX7720 availability

- NOT ITAR - EAR 9A515.e.
- Engineering Samples LX7720-ES – Q4 2015
- Evaluation Board LX7730-EVB – Q4 2015
- Class S built Samples Q2 2016
- Qualification Testing Complete Q4 2016
- QML Class V certification: Targeting mid-2017



132 pin ceramic quad flat pack

Visit our website for more information on our SSMs:

SSM page:

<http://www.microsemi.com/product-directory/radiation-hardened-devices/3574-space-system-managers>

LX7730 page:

<http://www.microsemi.com/product-directory/space-system-managers/3575-telemetry-controller-ic>

For Lead Customer Program inquiries, please contact:

[SSM\\_LCP@Microsemi.com](mailto:SSM_LCP@Microsemi.com)

# AAHS298B High Side Driver LX7710 Diode Array

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# AAHS298B – Rad Tolerant 8 Channel Source Driver

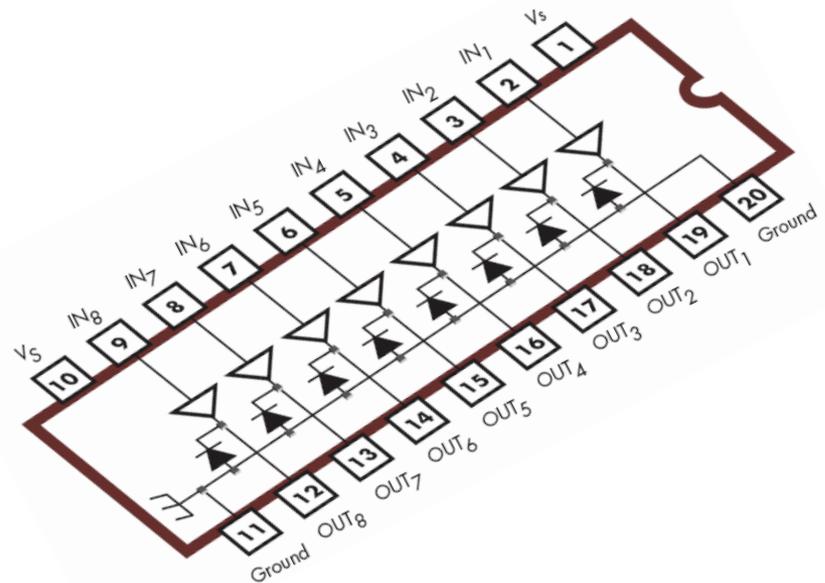


## Features

- 700mA per output source current
- Fully isolated channels with DI process
- 100krad TID, SEL immune
- 80V minimum output breakdown
- Low quiescent current consumption
- Internal ground clamp diodes
- Internal thermal shutdown
- TTL, 5V, and 12V logic compatible

## Applications

- Aerospace satellite manufacturers
  - Military power electronics control
- **In Production**
- **Samples available now**



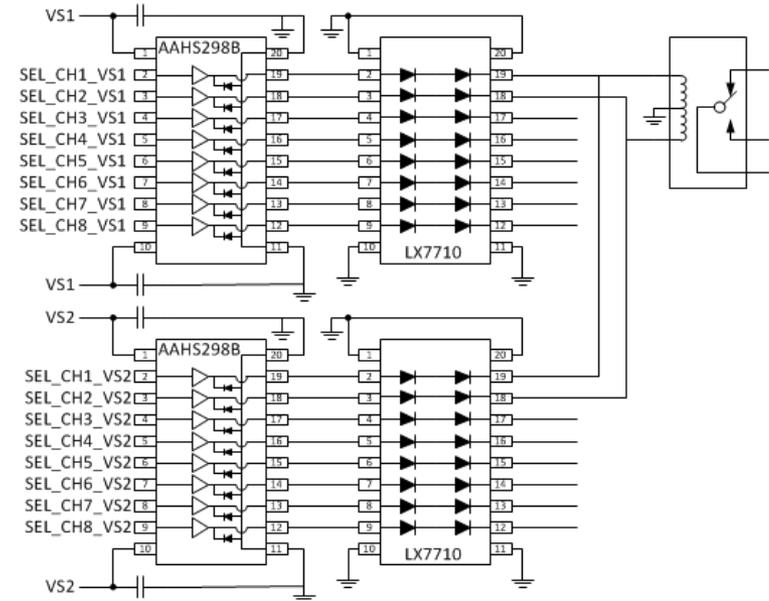
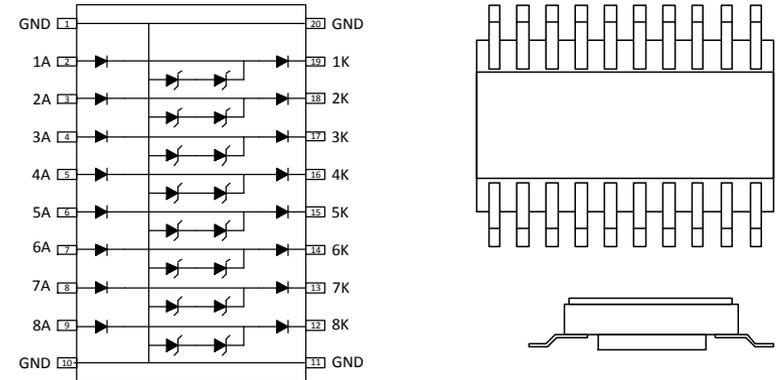
# LX7710 – Rad Tolerant Octal Diode Array with Redundancy

## Features

- 125V min breakdown voltage
- 1A current rating/diode
- 2800mA combined rating
- Redundancy if one diode fails
- Discharge path for inductive kick
- -55°C to 125°C ambient
- 20 lead ceramic SOIC

## Applications

- Relay Driver
- Uninterruptable power
- Redundant power sourcing
- Prevents channel backflow
- **In Development**
- **Samples available now**
- **Production Q1 calendar 2016**



# PWM Controllers Linear Regulators

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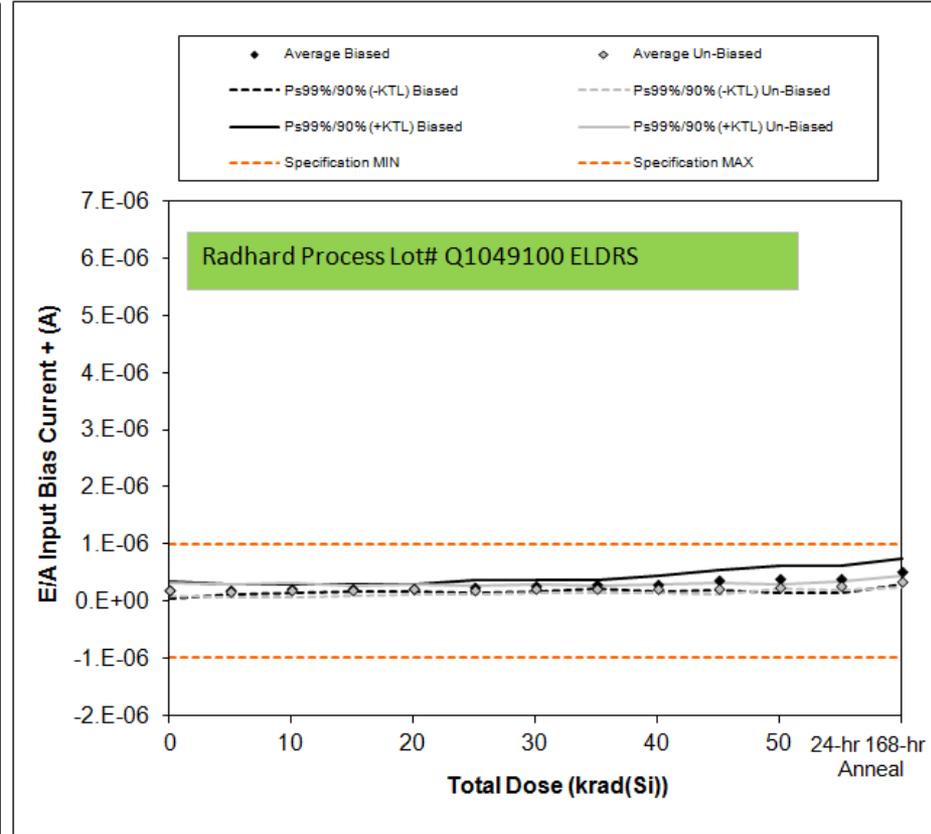
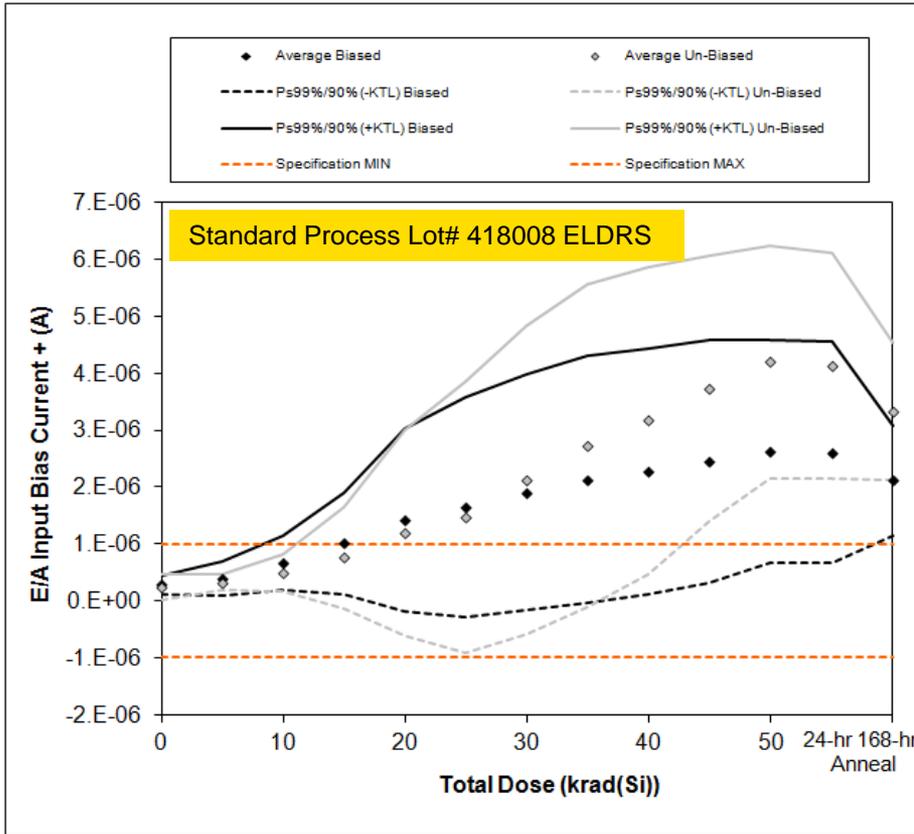
# SGR Product Offering

Microsemi offers new radiation tolerant enhancements to our popular Industry Standard products.

- PWM Controllers SGR1846 and SGR1845
- Linear Voltage Regulators SGR117 (positive) and SGR137 (negative)
- Guaranteed Radiation Tolerance performance - (Test data available)
  - TID to a minimum of 100krad(Si)
  - ELDRS to a minimum of 50krad(Si)
  - SEL immunity to a minimum of 87MeV cm<sup>2</sup>/mg
- Fit-Form-Function (FFF) equivalent of Industry Standard SG product
  - Process change ONLY\* and No design change\*
- Currently sampling and in production.

*\*The SGR117 is a design change from the SG117 and has extensive space heritage.*

# SG1846 ELDRS vs. SGR1846



■ STD process failed 10 Krad

■ New process passed 50 Krad

# Custom Capabilities

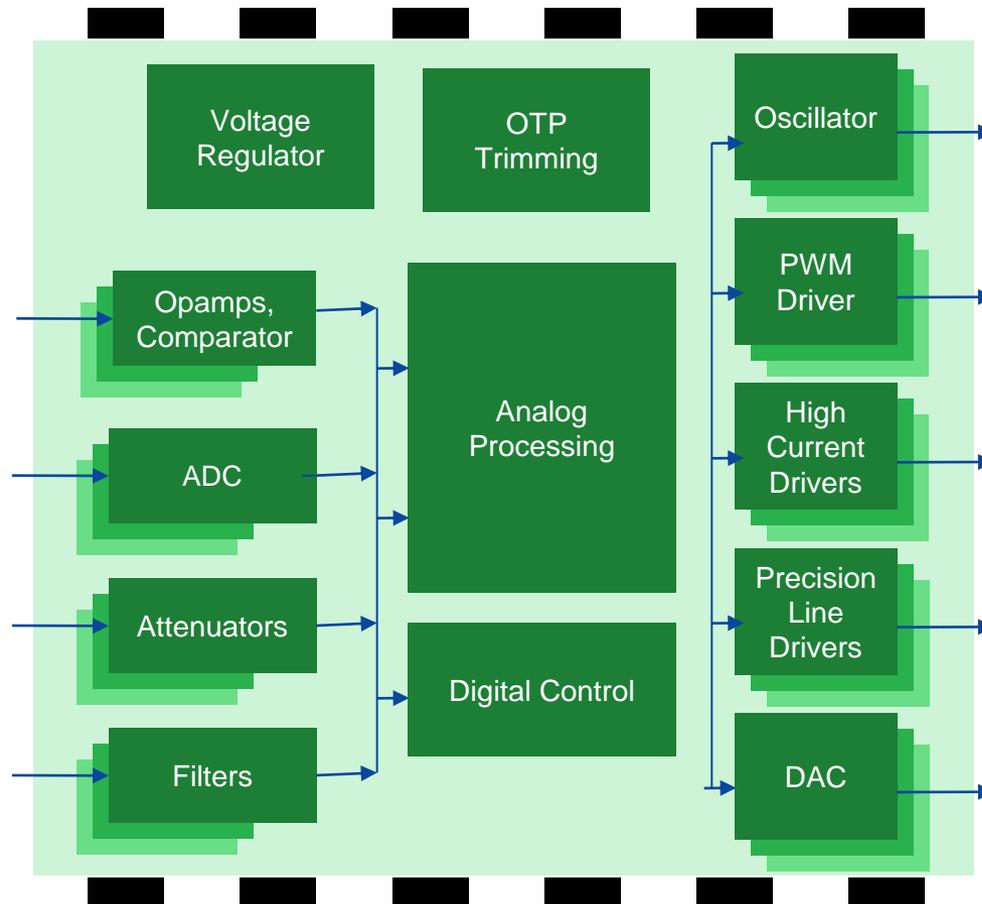
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# Custom ASIC Solutions

- 15 years of custom ASIC development
  - Design team in San Jose, CA
- Full custom designs, from specification to production
  - System integration
  - Second sourcing to replace obsolete parts
  - Customization of standard product
- Mixed-signal solutions integrating complex analog functions with up to 100k gates
- Challenging operating conditions
  - Extreme temperature environment (225°C)
  - Radiation tolerance by design for 100kRad TID minimum
  - SEL/SEU immunity, SETI mitigation
  - Cold-sparing on I/Os for redundant applications
- 10 year minimum process life guarantee and obsolescence management
- Screening to MIL-PRF-38535 Class B and Class S/V

# A typical Mixed-Signal ASIC

Typical design: 10 analog functions, 5k-100k digital gates, 12 man-months of engineering



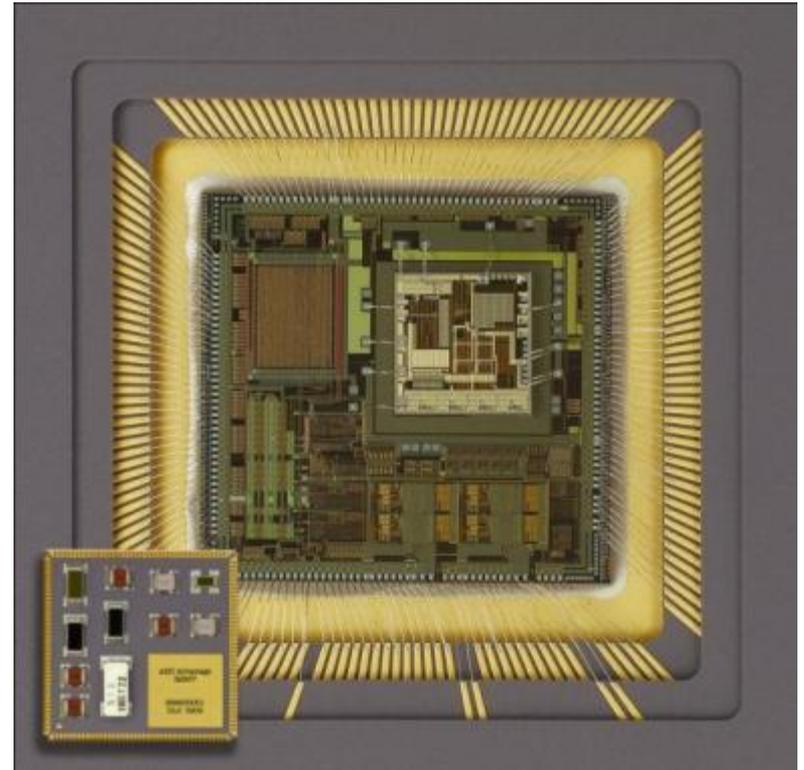
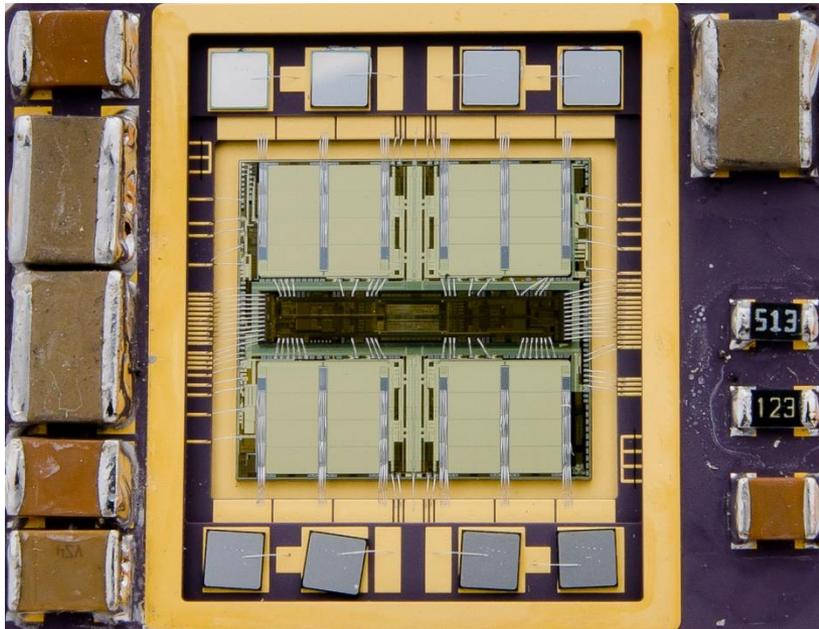
# Custom ASIC Expertise

Aerospace	Other Applications
<ul style="list-style-type: none"><li>Solid State Circuit Breakers</li><li>Pin-Diode Drivers</li><li>Solid State Relays</li><li>High-side drivers</li><li>RH Motor controller with 2A driver</li><li>RH RS485 Transceiver</li><li>Solid State LED Drivers</li><li>ARINC 429 TX/RX/ID</li><li>Cockpit light dimmers</li><li>Aircraft LVDT Controller</li><li>Navigation Gyro Controllers</li><li>RH Telemetry Controller</li></ul>	<ul style="list-style-type: none"><li>Non-Contact Rotational Sensor</li><li>Industrial Light Proximity Sensor</li><li>Capacitive Sensor Interface</li><li>Log Amplifier</li><li>15A SiC JFET Driver</li><li>MOSFET RF Driver</li><li><b>55 MHz Buffer Amplifier (Extreme Temp)</b></li><li><b>5MHz Oscillator Driver (Extreme Temp)</b></li></ul>

**Over 80 custom ASICs for aerospace and industrial applications**

# Custom Packaging

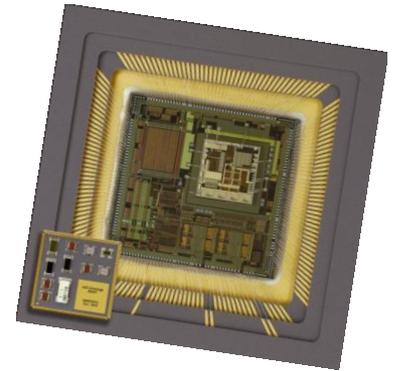
- Custom hermetic single and multi-layer ceramic packages
- Single or multi-chip (stacked or side-by-side)
- Addition of discrete components outside of the hermetic cover
- MIL-PRF-38534 assembly
- Design for low thermal resistance
- Design for high currents



# Custom Mixed-Signal for Space

## Telemetry ASIC for Satellite

- Multiple analog inputs: single ended, differential, bi-level, current conditioning
- High precision analog: regulator, oscillator, 8-bit A/D, 0.5% current source
- Full digital host interface with dual RS485 transceiver
- Custom hermetic package with back-side discrete
- Cold-sparing on all pins
- 100krad(Si) total dose, ELDR, SEL immune



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# Thank You



**Microsemi.**

**Power Matters.™**

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